PRODUCT / PROCESS CHANGE NOTIFICATION

1. PCN basic data		
1.1 Company	T	STMicroelectronics International N.V
1.2 PCN No.		ADG/18/10745
1.3 Title of PCN		Additional assembly and test line qualification for FERD diodes housed in DPAK package
1.4 Product Category		FERD diodes in DPAK package
1.5 Issue date		2018-02-20

2. PCN Team		
2.1 Contact supplier		
2.1.1 Name	MARCELI SMIALKOWSKI	
2.1.2 Phone	+44 1628896277	
2.1.3 Email	marceli.smialkowski@st.com	
2.2 Change responsibility		
2.2.1 Product Manager	Richard RENARD	
2.1.2 Marketing Manager	Franck DUCLOS	
2.1.3 Quality Manager	Jean-Paul REBRASSE	

3. Change		
3.1 Category	3.2 Type of change	3.3 Manufacturing Location
Machines	(Not Defined)	subco in China (location A+B)

4. Description of change			
	Old	New	
4.1 Description	back-end subco in China (location A)	back-end subco in China (location A) back-end subco in China (location B)	
4.2 Anticipated Impact on form,fit, function, quality, reliability or processability?	no		

5. Reason / motivation for change	
5.1 Motivation	investment on FERD capacity increase
5.2 Customer Benefit	CAPACITY INCREASE

6. Marking of parts / traceability of change		
6.1 Description	internal codification, trace code.	

7. Timing / schedule		
7.1 Date of qualification results	2018-02-19	
7.2 Intended start of delivery	2018-05-21	
7.3 Qualification sample available?	Upon Request	

8. Qualification / Validation			
8.1 Description			
8.2 Qualification report and qualification results		Issue Date	

	9. Attachments (additional documentations)
10745 Public product.pdf 10745 PCN DPAK VF.pdf	

10. Affected parts		
10. 1 Current		10.2 New (if applicable)
10.1.1 Customer Part No	10.1.2 Supplier Part No	10.1.2 Supplier Part No
	FERD30H100SB-TR	

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Public Products List

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PCN Title: Additional assembly and test line qualification for FERD diodes housed in DPAK package

PCN Reference: ADG/18/10745

Subject: Public Products List

Dear Customer,

Please find below the Standard Public Products List impacted by the change.

FERD15S50SB-TR	FERD20H100SB-TR	FERD30H100SB-TR
FERD20S100SB-TR		

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